2SB1048

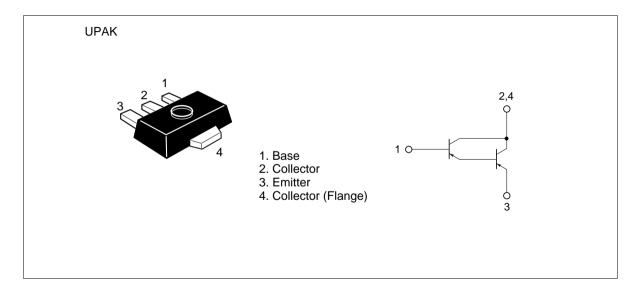
Silicon PNP Epitaxial, Darlington

HITACHI

Application

High gain amplifier

Outline





2SB1048

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-60	V
Collector to emitter voltage	V _{CEO}	-60	V
Emitter to base voltage	V_{EBO}	- 7	V
Collector current	I _c	– 1	A
Collector peak current	i _{C(peak)} *1	-2	A
Collector power dissipation	P _c * ²	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%

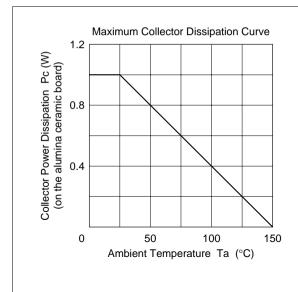
2. Value on the alumina ceramic board (12.5 \times 30 \times 0.7 mm)

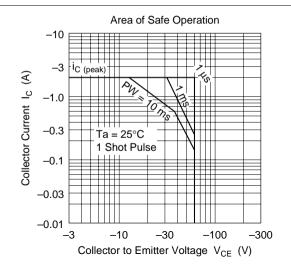
Electrical Characteristics ($Ta = 25^{\circ}C$)

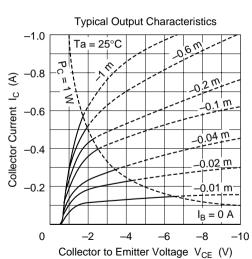
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	-60	_	_	V	$I_{c} = -10 \ \mu\text{A}, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\text{(BR)CEO}}$	-60	_	_	V	$I_C = -1 \text{ mA}, R_{BE} = \infty$
Collector cutoff current	I _{CBO}	_	_	-10	μΑ	$V_{CB} = -60 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	_	-10	μΑ	$V_{EB} = -7 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE}	2000	_	100000)	$V_{CE} = -3 \text{ V}, I_{C} = -500 \text{ mA}^{*1}$
Collector to emitter saturation voltage	$\boldsymbol{V}_{\text{CE(sat)}}$	_	_	-2.0	V	$I_{\rm C} = -500 \text{ mA}, I_{\rm B} = -1 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	_	-2.0	V	$I_{\rm C} = -500 \text{ mA}, I_{\rm B} = -1 \text{ mA}^{*1}$

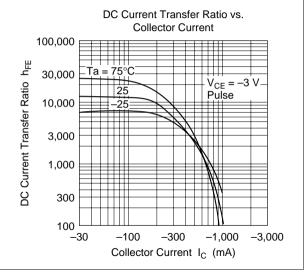
Notes: 1. Pulse test

2. Marking is "BT"

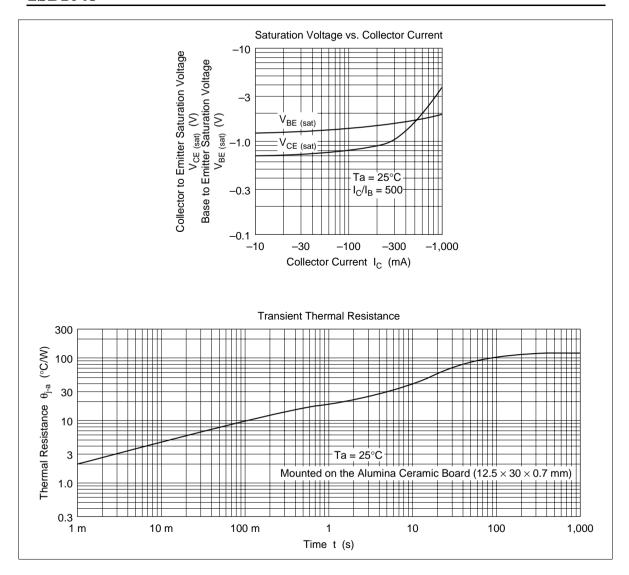




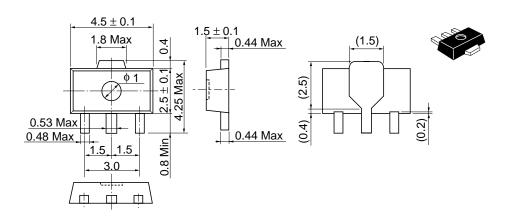




2SB1048



Unit: mm



Hitachi Code	UPAK
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.050 g

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